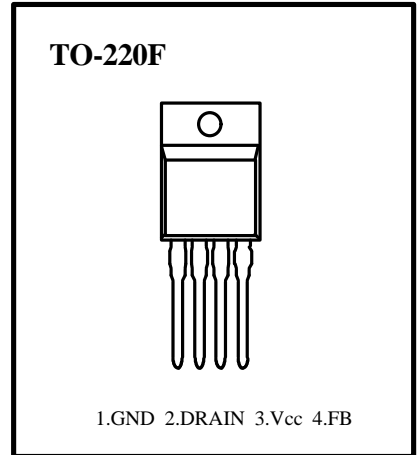


## FEATURES

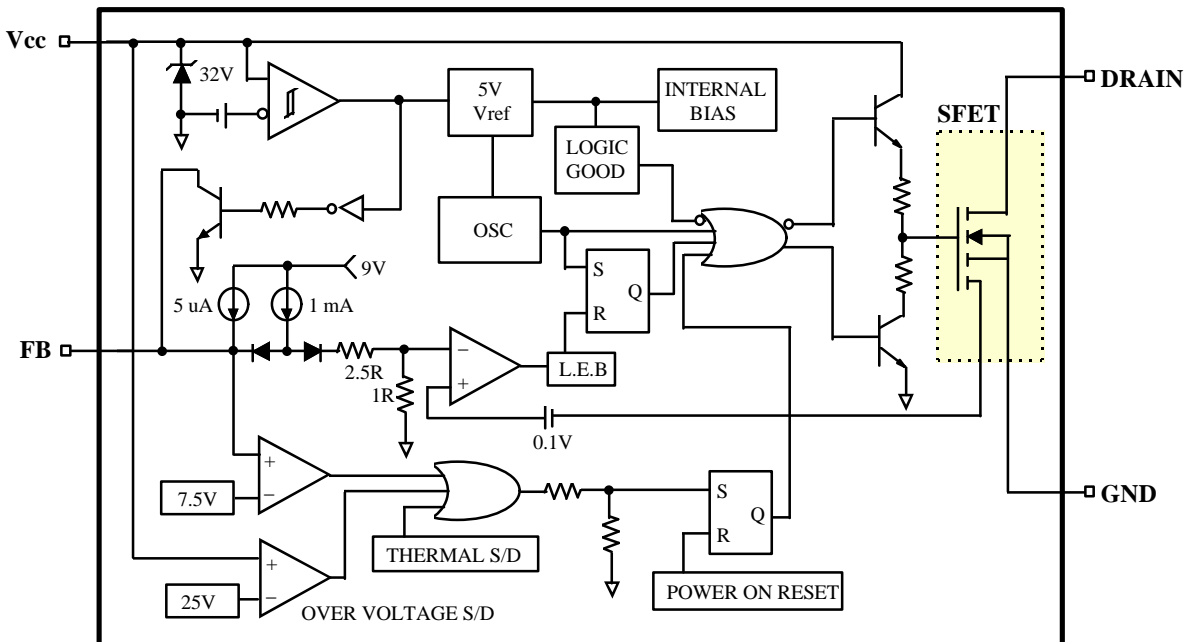
- Precision fixed operating frequency (50KHz)
- Pulse by pulse over current limiting
- Over Current Protection
- Over Voltage Protection(min. 23V)
- Internal thermal shutdown function
- Under voltage lockout
- Internal high voltage sense FET
- Latch up mode

## PRODUCT SUMMARY

Part Number	BV <sub>dss</sub>	R <sub>ds(on)</sub>	I <sub>D</sub>
KA1L0380	800V	5.0 Ω	3A



## BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Value	Unit
Drain - Source(GND) Voltage (1)	V <sub>DSS</sub>	800	V
Drain - Gate Voltage (R <sub>GS</sub> = 1M $\Omega$ )	V <sub>DGR</sub>	800	V
Gate - Source(GND) Voltage	V <sub>GS</sub>	$\pm 30$	V
Drain Current Pulsed (2)	I <sub>DM</sub>	12	A <sub>DC</sub>
Single Pulsed Avalanche Energy (3)	E <sub>AS</sub>	95	mJ
Avalanche Current	I <sub>AS</sub>	-	A
Continuous Drain Current (T <sub>c</sub> = 25 °C)	I <sub>D</sub>	3.0	A <sub>DC</sub>
Continuous Drain Current (T <sub>c</sub> = 100 °C)	I <sub>D</sub>	2.1	A <sub>DC</sub>
Supply Voltage	V <sub>CC</sub>	30	V
Analog Input Voltage Range	V <sub>FB</sub>	-0.3 ~ V <sub>SD</sub>	V
Total Power Dissipation	P <sub>D</sub> ( wt H/S)	35	W
	Derating	0.28	W/°C
Operating Temperature	T <sub>OPR</sub>	- 25 ~ + 85	°C
Storage Temperature	T <sub>STG</sub>	- 55 ~ + 150	°C

Notes: (1) T<sub>j</sub> = 25°C to 150°C

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3) L = 41mH, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25 $\Omega$  , starting T<sub>j</sub> = 25°C

## ELECTRICAL CHARACTERISTICS ( SFET part )

( T<sub>a</sub> = 25°C unless otherwise specified )

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	800	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> =50 $\mu$ A
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	-	-	50	$\mu$ A	V <sub>D</sub> S=Max, Rating, V <sub>GS</sub> =0V
		-	-	200	$\mu$ A	V <sub>D</sub> S=0.8Max, Rating, V <sub>GS</sub> =0V T <sub>C</sub> =125°C
R <sub>DS(on)</sub>	Static Drain-Source On Resistance(4)	-	4.0	5.0	$\Omega$	V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.5A

**ELECTRICAL CHARACTERISTICS ( SFET part continued)**

( Ta = 25°C unless otherwise specified )

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
gfs	Forward Transconductance(4)	1.5	2.5	-	mho	V <sub>DS</sub> =15V, I <sub>D</sub> =1.5A
C <sub>iss</sub>	Input Capacitance	-	779	-	pF	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz
C <sub>oss</sub>	Output Capacitance	-	75.6	-		
C <sub>rss</sub>	Reverse Transfer Capacitance	-	24.9	-		
td(on)	Turn On Delay Time	-	40	-	nS	V <sub>DD</sub> = 0.5BV <sub>DSS</sub> , I <sub>D</sub> = 3.0A (MOSFET switching time are essentially independent of operating temperature )
tr	Rise Time	-	95	-		
td(off)	Turn Off Delay Time	-	150	-		
tf	Fall Time	-	60	-		
Q <sub>g</sub>	Total Gate Charge ( Gate-Source + Gate-Drain )	-	-	34	nC	V <sub>GS</sub> = 10V, I <sub>D</sub> = 3.0A V <sub>DS</sub> = 0.5BV <sub>DSS</sub> (MOSFET switching time are essentially independent of operating temperature )
Q <sub>gs</sub>	Gate-Source Charge	-	7.2	-		
Q <sub>gd</sub>	Gate-Drain(Miller) Charge	-	12.1	-		

**Notes:** (1) T<sub>J</sub> = 25°C to 150°C

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3) L = 41mH, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25Ω , starting T<sub>j</sub> = 25°C

(4) Pulse Test : Pulse width ≤ 300μs, Duty Cycle ≤ 2%

**ELECTRICAL CHARACTERISTICS ( Control part )**

( Ta = 25°C unless otherwise specified )

Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
<b>REFERENCE SECTION</b>						
Vref	Output Voltage (Note 1)	4.80	5.00	5.20	V	Ta = 25°C
Vref/ΔT	Temperature Stability (Note 1&2)	-	0.3	0.6	mV/°C	-25°C ≤ Ta ≤ +85°C
<b>OSCILLATOR SECTION</b>						
FOSC	Initial Accuracy	45	50	55	KHz	Ta = 25°C
ΔF/ΔT	Frequency Change with Temperature (Note 2)	-	± 5	± 10	%	-25°C ≤ Ta ≤ +85°C
<b>PWM SECTION</b>						
DMAX	Maximum Duty Cycle	74	77	80	%	
<b>FEEDBACK SECTION</b>						
IFB	Feedback Source Current	0.7	0.9	1.1	mA	Ta = 25°C , 0 V ≤ Vfb ≤ 3V
Idelay	Shutdown Delay Current	4.0	5.0	6.0	uA	Ta = 25°C , 5 V ≤ Vfb ≤ VSD
<b>OVER CURRENT PROTECTION SECTION</b>						
IL(MAX)	Over Current Protection	1.89	2.15	2.41	A	Max. Inductor Current
<b>UVLO SECTION</b>						
Vth(H)	Start Threshold Voltage	14	15	16	V	
Vth(L)	Minimum Operating Voltage	9	10	11	V	After turn on

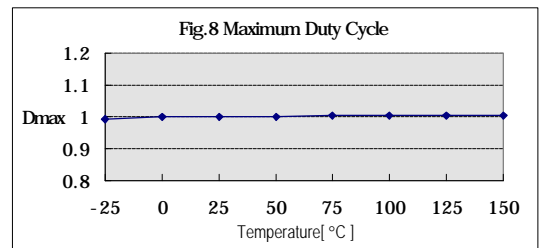
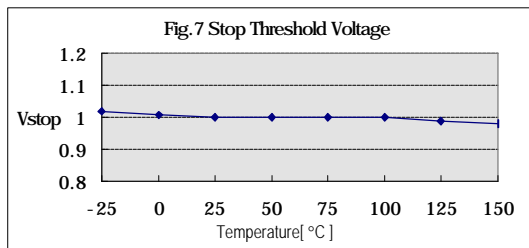
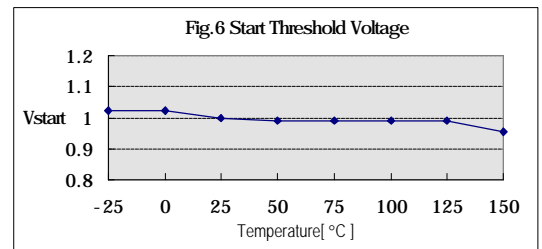
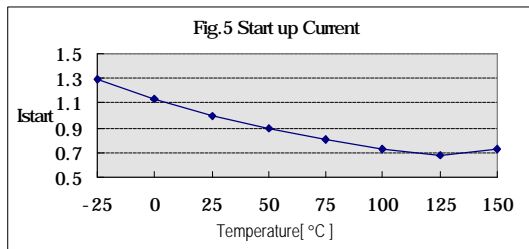
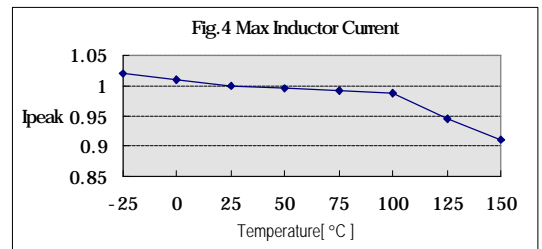
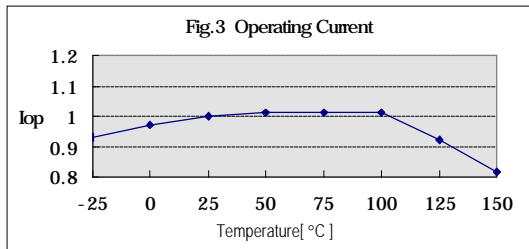
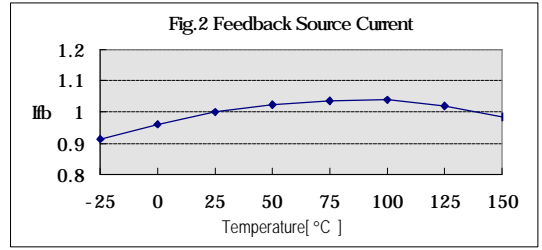
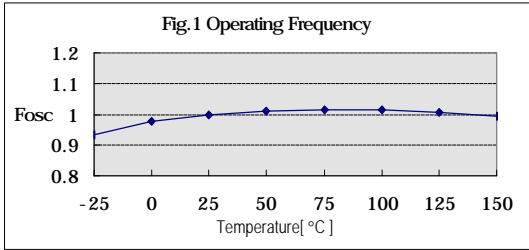
**ELECTRICAL CHARACTERISTICS ( Continued)**

( Ta = 25°C unless otherwise specified )

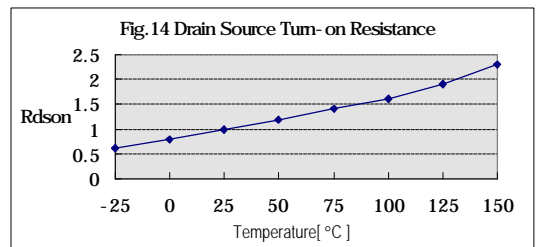
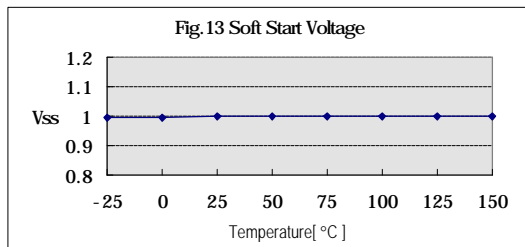
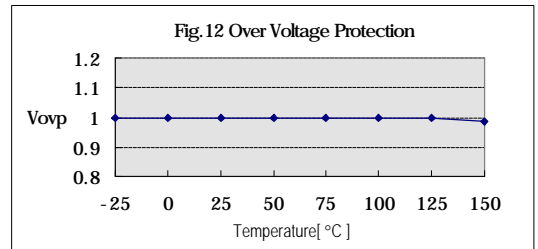
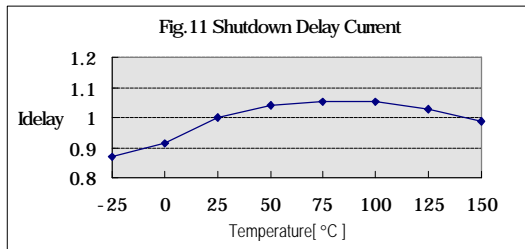
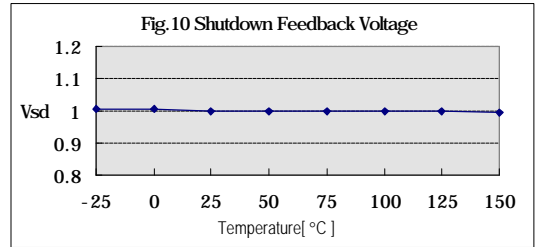
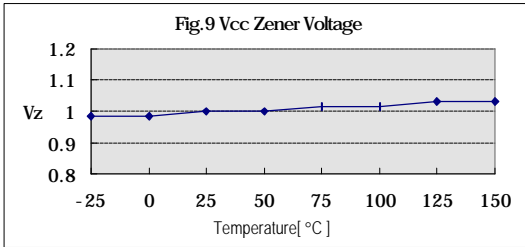
Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
<b>TOTAL STANDBY CURRENT SECTION</b>						
I <sub>ST</sub>	Start up Current	0.1	0.3	0.45	mA	V <sub>CC</sub> = 14V
I <sub>OPR</sub>	Operating Supply Current ( control part only )	6	12	18	mA	T <sub>a</sub> = 25°C
V <sub>Z</sub>	V <sub>CC</sub> Zener Voltage	30	32.5	35	V	I <sub>CC</sub> = 20mA
<b>SHUTDOWN SECTION</b>						
V <sub>SD</sub>	Shutdown Feedback Voltage	6.9	7.5	8.1	V	
T <sub>SD</sub>	ThermalShutdownTemperature(T <sub>j</sub> )	140	160	-	°C	(Note 1)
V <sub>ovp</sub>	Over Voltage Protection Voltage	23	25	28	V	

- Notes:** (1) These parameters, although guaranteed, are not 100% tested in production  
(2) These parameters, although guaranteed, are tested in EDS(wafer test) process

TYPICAL PERFORMANCE CHARACTERISTICS

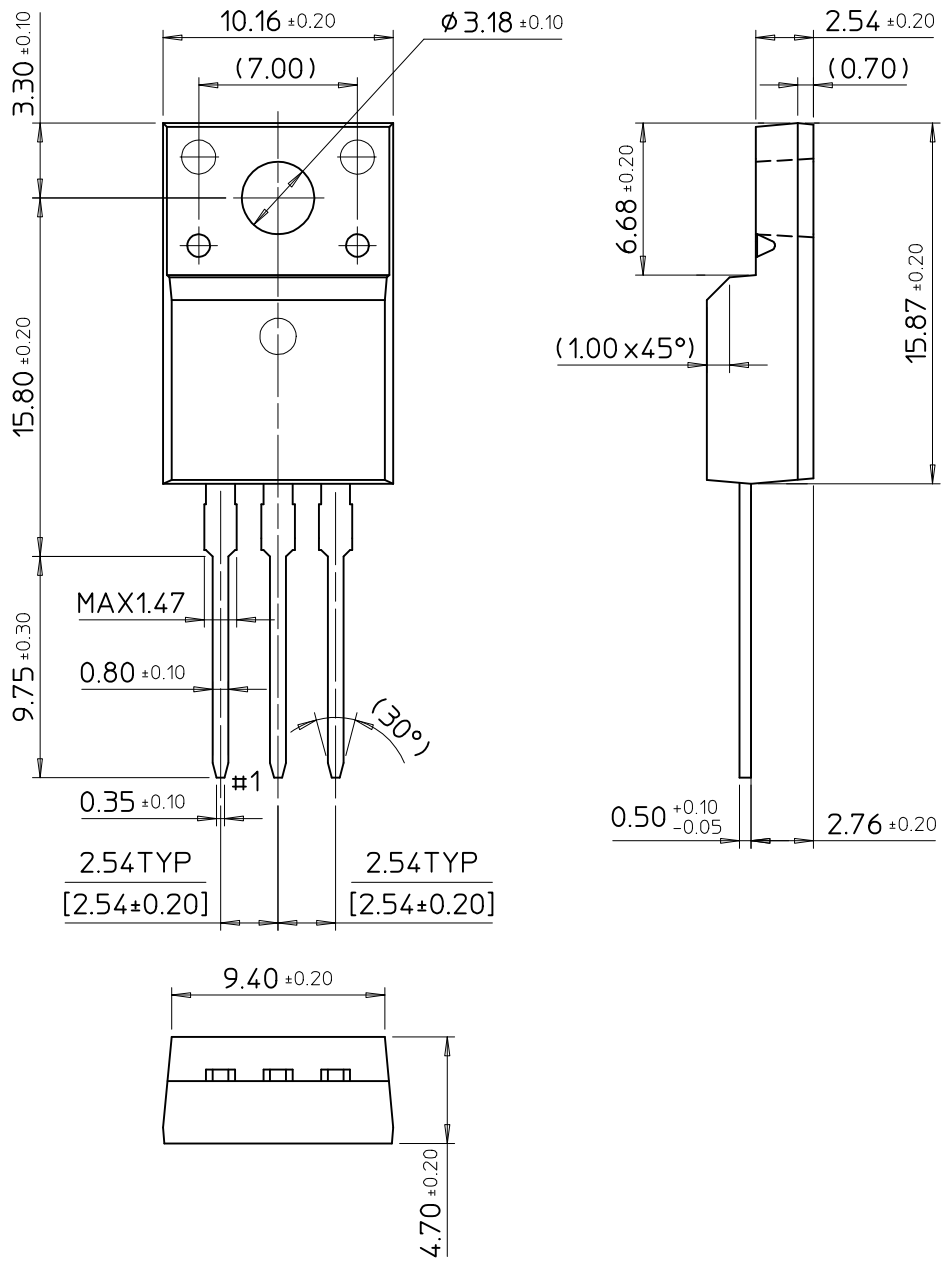


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



# TO-220F

Dimensions in Millimeters



SAMSUNG ELECTRONICS CO.,LTD.